| © Copyright 2                          | <b>omposition De</b><br>005. IPC, Bannockl<br>nd Pan-American c                        | burn, Illinois. A              | ll rights reserved utions. | under both           | This docume<br>level parts, ti                                   | ent is a declarat<br>he declaration of | ion of the su | ibstances v<br>s all lower | within the manufacture level materials for v | urer listed<br>which the | item. Note: i<br>manufacturer   | f the item is an as<br>has engineering | sembly with low responsibility. |  |
|--|--|--------------------------------|----------------------------|----------------------|--|--|---------------|----------------------------|--|--------------------------|---------------------------------|--|---------------------------------|--|
|  | eb Site for Information on IPC-1752 Standard Form Type www.ipc.org/IPC-175x Distribute |                                |                            | *                    | Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Materi |  |               |                            |  | als and Mfg Information  |                                 |  |                                 |  |
| Supplier Information                   |  |                                |                            |                      |  |  |               |                            |  |                          |                                 |  |                                 |  |
| Company name*                          | Company uni  | Company unique ID              |                            |                      | Unique ID Authority  |  |               |                            | Respon                                       | Response Date*           |                                 |  |                                 |  |
| onsemi                                 |  |                                |                            |                      |  |  |               |                            |  | 2025-00                  | 2025-06-07                      |  |                                 |  |
| Contact Name Title - Contact           |  |                                | ct                         |                      |  | Phone - Contact*                       |               |                            |  | Email -                  | Email - Contact*                |  |                                 |  |
| Product-Env-Stewards Produ             |  |                                | Product Enviro Compliance  |                      |  | NA                                     |               |                            |  | Produ                    | Product-Env-Stewards@onsemi.com |  |                                 |  |
| Authorized Representative* Title - Rep |  |                                | presentative               |                      |  | Phone - Representative*                |               |                            |  | Email -                  | Email - Representative*         |  |                                 |  |
| Product-Env-Stewards Pr                |  |                                | Product Enviro Compliance  |                      |  | NA                                     |               |                            |  | Produ                    | Product-Env-Stewards@onsemi.com |  |                                 |  |
| Requester Item Number                  | Mfr Iten   | n Number                       | Mfr Item Name              |                      |  | Effective Date                         | Version       | N                          | Manufacturing Site                           |                          | Weight*                         | UOM                                    | Unit Type                       |  |
|  | FAN491   | 49103AUC34AX DC/DC Buck -Boost |                            | post 2.5A            |  | 2025-06-07                             |               | P                          | РВВ  |                          | 3.347343                        | mg                                     | Each                            |  |
| Ianufacturing Proccess Info            | ormation   |                                |                            |                      |  |  |               |                            |  |                          |                                 |  |                                 |  |
| Terminal Plating / Grid Ar             | ating / Grid Array Material Terminal Base A  |                                | Alloy                      | J-STD-020 MSL Rating |  | Peak Process Body Temperature          |               | e Max Time at Pea          | Time at Peak Tempera                         |                          | er of Reflow Cyd                | eles                                   |                                 |  |
| SnAgCu CU Alloy                        |  | CU Alloy                       |                            | 1                    |  | 260                                    |               | C                          | 30   | seco                     | nds 3                           |  |                                 |  |
| omments                                |  |                                |                            |                      |  |  |               |                            |  |                          |                                 |  |                                 |  |
| vel 1 - maximum time at peak tem       | perature during so   | Idering is 10-3                | 0 seconds                  |                      |  |  |               |                            |  |                          |                                 |  |                                 |  |
| or more information regarding ma       | terial composition   | please refer to                | page 3                     |                      |  |  |               |                            |  |                          |                                 |  |                                 |  |

| RoHS Material Composition Declaration  |  |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |
|--|--|--|---|---|---|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>v others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the   | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and co<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa  | ances per the definitio  | on above  | Supplier Acceptance                             | * Accepted  |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per   | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU   |  |   |   |   |  |  |  |  |  |  |
| Declaration Signature  |  |  |   |   |   |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester  | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska  | Le   |   |   |   |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material     | mogeneous Material Weight Unit of Measure |    | Level    | Substance  | CAS              |  | Weight | Unit of Measure |
|--------------------------|---|----|----------|--|------------------|--|--------|-----------------|
| Backside Protection Film | 0.138305                                  | mg | Supplier | Ortho Cresol Novolac Resin                             | 29690-82-2       |  | 0.0289 | mg              |
|                          |   |    | Supplier | Carbon Black (C)                                       | 1333-86-4        |  | 0.0026 | mg              |
|                          |   |    | Supplier | Silica (SiO2)  | 14464-46-1       |  | 0.0778 | mg              |
|                          |   |    | Supplier | 2,4,6-Tris[Bis(Methoxymethyl)Amino]-<br>1,3,5-Triazine | 3089-11-0        |  | 0.0289 | mg              |
| Die                      | 2.621417                                  | mg | Supplier | Silicon (Si)   | 7440-21-3        |  | 2.6214 | mg              |
| Protection coat          | 0.038774                                  | mg |          | Polyimide  | proprietary data |  | 0.0388 | mg              |
| Solder Ball              | 0.547544                                  | mg | Supplier | Silver (Ag)  | 7440-22-4        |  | 0.0309 | mg              |
|                          |   |    | Supplier | Tin (Sn)   | 7440-31-5        |  | 0.5133 | mg              |
|                          |   |    | Supplier | Copper (Cu)  | 7440-50-8        |  | 0.0033 | mg              |
| Under Bump Metal         | 0.001303                                  | mg | Supplier | Titanium (Ti)  | 7440-32-6        |  | 0.0003 | mg              |
|                          |   |    | Supplier | Copper (Cu)  | 7440-50-8        |  | 0.001  | mg              |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 signa range of distribution unless otherwise noted).